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Features

- Operates as a 4-bit GTL-/GTL/GTL+ Sampling receiver or as a LVTTL to GTL-/GTL/GTL+ Driver
- 3.0 V to 3.6 V Operation with 5 V Tolerant LVTTL Input
- GTL Input and Output 3.6 V Tolerant
- Vref Adjustable from 0.5 V to VCC/2
- Partial Power-down Permitted
- Under-Voltage Lockout (UVLO)
- ESD Protection exceeds 2000 V HBM per JESD22-A114 and 1000 V CDM per JESD22-CC101
- Latch-up Protection Exceeds 500 mA per JESD78
- Package Offered: TSSOP14
- –40°C to 85°C Operating Temperature Range

Applications

- Server
- Base Station
- Wire-line Communication

Description

The FXGL2014 is a 4-channel translator to interface between 3.3-V LVTTL chip set I/O and Xeon processor GTL–/GTL/GTL+ I/O.

The FXGL2014 integrates ESD protection cells on all terminals and is available in a TSSOP package (5.0 mm \times 4.4 mm). The device is characterized over free air temperature range of -40°C to 85°C.

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FXGL2014MTCX	-40 to +85°C	5.0 mm × 4.4 mm, 0.65 mm Pitch, 14 Lead TSSOP Package	Tape & Reel



Functional Description

INPUT	INPUT/OUTPUT		
DIR	A (LVTTL)	B (GTL)	
High Voltage	Input	Bn = An	
Low Voltage	An = Bn	Input	

FXGL2014 — 4-Channel LVTTL to GTL Transceiver

Pin Configuration



Figure 1. Pin Assignment (Top Through View)

Pin Descriptions

Pin Name	Pin #	Description	
A0	13		
A1	12		
A2	10		
A3	9		
B0	2		
B1	3	GTL Data Input / Output	
B2	5		
B3	6		
DIR	1	Direction Control Input (LVTTL)	
	7		
GND	8	Ground	
	11		
VCC	14	Supply Voltage	
VREF	4	GTL Reference Voltage	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
V _{cc}	Supply Voltage		-0.5	4.6	V
I _{IK}	Input Clamping Current, VI<0 V			-50	mA
V_{DIR}	Input Control Voltages DIR		-0.5	6	V
M	A Port		-0.5	6.5	V
VI	input voltage	B Port	-0.5	4.6	V
І _{ск}	Control Input Clamp Current, V _O < 0 V			-50	mA
V	Quitaut Voltage in Off State	A Port	-0.5	6.5	V
V _O	Output Voltage in On-State	B Port		4.6	v
	Current into any output in the Low State	A Port		40	
IOL	B Port			80	mA
I _{он}	Current into any output in the High State			-40	mA
T _{stg}	Storage Temperature Range			150	°C
M	V _{ESD} Human Body Model (HBM), JEDEC: JESD22-A114 AI Charged Device Model, JEDEC: JESD22-C101 AI		2		
VESD			1		κν

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. ON does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Тур.	Max.	Unit	
V _{cc}	Supply Voltage		3.0	3.3	3.6	V	
			0.85	0.90	0.95		
V_{TT}	Termination Voltage	GTL	1.14	1.20	1.26	V	
		GTL+	1.35	1.50	1.65		
		Overall	0.5	2/3V _{TT}	V _{CC} /2		
N/	V _{REF} Reference Voltage	GTL-	0.50	0.60	0.63	V	
VREF		GTL	0.76	0.80	0.84		
		GTL+	0.87	1.00	1.10		
M		A Port	0	3.3	5.5 ⁽³⁾	V	
VI	input voltage	B Port	0	V _{TT}	3.6	v	
V	High lovel logut Veltage	A Port and DIR	2			V	
VIH	Fligh-level input voltage	B Port	V _{REF} + 50 mV			v	
V		A Port and DIR			0.8	v v	
VIL	Low-level input voltage	B Port			$V_{REF} - 50 \text{ mV}$		
	Low lovel Output Current	A Port			20		
IOL	Low-level Output Current	B Port	50			mA	
I _{он}	High-level Output current	A Port			-20	mA	

Notes:

1. Over operating free-air temperature range (unless otherwise noted).

2. All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

3. The V_I (max) of LVTTL port is 3.6 V if configured as output (DIR=L).

Thermal Information

	Thermal Metric		
R _{θJA}	Junction-to-Ambient Thermal Resistance	116	°C M/
R _{0JC(top)}	Junction-to-Case (top) Thermal Resistance	17	0/22

DC Electrical Characteristics

Specified at $T_A = -40^{\circ}C$ to $85^{\circ}C$ (unless otherwise noted).

• • •			-40°C	11			
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
	A Deat	V_{CC} = 3 to 3.6 V, I_{OH} = -100 μ A	V _{CC} - 0.2			N	
V _{OH}	A Port	V _{CC} = 3 V, I _{OH} = -16 mA	2.0			V	
	A Port	$V_{CC} = 3 \text{ V}, I_{OL} = 8 \text{ mA}$		0.28	0.40		
	A Port	V _{CC} = 3 V, I _{OL} = 12 mA		0.42	0.60		
Vol	A Port	V _{CC} = 3 V, I _{OL} = 16 mA		0.55	0.80	V	
	B Port	$V_{CC} = 3 \text{ V}, I_{OL} = 40 \text{ mA}$		0.23	0.40		
		$V_{CC} = 3.6 V, V_1 = V_{CC}$			±1		
	A Port	$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = 0 \text{ V}$			±1	μA	
I ₁		$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = 5.5 \text{ V}$			5		
	B Port	$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = \text{V}_{TT} \text{ or GND}$			±1	μA	
	Control Pin	$V_{CC} = 3.6 V, V_1 = V_{CC} \text{ or } 0 V$			±1	μA	
	OFF-State Output Current on A Port	$V_{CC} = 0 \text{ V}, V_{IO} = 0 \text{ to } 3.6 \text{ V}$			±10		
I _{off}	OFF-State Output Current on A Port	V_{CC} = 0 V, V_{IO} = 3.6 to 5.5 V			±100	μA	
	OFF-State Output Current on B Port	$V_{CC} = 0 V$, $V_{IO} = 0$ to 3.6 V			±10		
	A Port	$\label{eq:Vcc} \begin{array}{l} V_{CC}=3.6 \ V, \ V_{I}=V_{CC} \ or \ GND, \\ I_{O}=0 \end{array}$		3	10	mA	
ICC	B Port	$\label{eq:Vcc} \begin{array}{l} V_{CC}=3.6 \ V, \ V_{I}=V_{TT} \ or \ GND, \\ I_{O}=0 \end{array}$		3	10	mA	
ΔI_{CC}	A Port or Control Input	$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = V_{CC} - 0.6 \text{ V}$			500	μA	
V _{UVLO} ⁽⁴⁾	Under-Voltage Lockout Threshold	$V_{CC} = 0$ to 3 V	1.5			V	
C1 ⁽⁴⁾	Input Capacitance of Control Pin	$V_{CC} = 3 \text{ to } 3.6 \text{ V}, \text{ V}_{I} = 3.0 \text{ V or } 0 \text{ V}$		2.0		pF	
A (4)	A Port	V_{CC} = 3 to 3.6 V, V_O = 3.0 V or 0 V		4.0		-	
C ₁₀ ⁽⁴⁾	B Port	$V_{CC} = 3 \text{ to } 3.6 \text{ V}, V_{O} = V_{TT} \text{ or } 0 \text{ V}$		5.46		р⊦	

Note:

4. Guaranteed by characterization and / or design. Not production tested.

AC Electrical Characteristics

				GTL-	-		GTL			GTL+		
		V _{cc} =	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 3.3 V ± 0.3 V					
Symbol	Paramet	er	V	V _{REF} = 0.6 V		VR	V _{REF} = 0.8 V		V _{REF} = 1 V		Unit	
			v	тт = 0 .	9 V	v	тт = 1.2	2 V	V	гт = 1.5	5 V	
			Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	
t _{PLH}	Low to High Propagation Delay ⁽⁵⁾	An to Dr		2.8	5.0		2.8	5.0		2.8	5.0	
t _{PHL}	High to Low Propagation Delay ⁽⁵⁾	An to Bn		3.3	7.0		3.4	7.0		3.4	7.0	ns
t _{PLH}	Low to High Propagation Delay ⁽⁵⁾	Pa to An		5.3	8.0		5.2	8.0		5.1	8.0	20
t _{PHL}	High to Low Propagation Delay ⁽⁵⁾	Bn to An -		5.2	8.0		4.9	7.0		4.7	7.0	115

Note:

5. Guaranteed by characterization and / or design. Not production tested.







Application Information

Application Overview

The FXGL2014 is a 4-channel translating transceiver designed for 3.3-V LVTTL system interface with a GTL–/GTL/GTL+ bus, where GTL–/GTL/GTL+ refers to the reference voltage of the GTL bus and the input/output voltage thresholds associated with it.

The direction pin allows the part to function as either a GTL-to-LVTTL sampling receiver or as a LVTTL-to-GTL interface.

The FXGL2014 performs translation in two directions. One direction is GTL–/GTL/GTL+ to LVTTL when DIR is tied to GND. With appropriate V_{REF} set up, the GTL input can be compliant with GTL–/GTL/GTL+. Another direction is LVTTL to GTL–/GTL/GTL+ when DIR is tied to VCC. 3.6 V tolerance on the GTL output allows the GTL outputs to pull up to any voltage level under 3.6 V.

Feature Description

5 V Tolerance on LVTTL Input

The FXGL2014 LVTTL inputs (only) are tolerant up to 5.5 V and allow direct access to TTL or 5 V CMOS inputs. The LVTTL outputs are not 5.5 V tolerant.

3.6 V Tolerance on GTL Input / Output

The FXGL2014 GTL inputs and outputs operate up to 3.6 V, allowing the device to be used in higher voltage open-drain output applications.

Ultra-Low V_{REF} and High Bandwidth

FXGL2014's V_{REF} tracks down to 0.5 V for low voltage CPUs with excellent propagation delay performance. This feature allows the FXGL2014 to support high data rates with the GTL- bus.

Under-Voltage Lockout (UVLO)

Under-voltage lockout circuit is integrated internal. This feature makes sure the data transferred effectively when power unstable.

Typical Application

GTL-/GTL/GTL+ to LVTTL

Select appropriate V_{TT}/V_{REF} based upon GTL-/GTL/GTL+. The parameters in Recommended Operating Conditions are compliant to the GTL specification.

The FXGL2014 requires industrial standard LVTTL and GTL inputs. The design example in the Application Information shows standard voltage level and typical resistor values.



Figure 8.	Application Diagram for GTL to LVTTL
Table 1.	Application Table for GTL to LVTTL

	Port B to Port A
	GTL to LVTTL
VCC	3.3 V
VREF	2*VTT/3
VTT	1.0 V
DIR	GND
RT	75 Ω
R1	49.9 Ω
R2	100 Ω

LVTTL to GTL-/GTL/GTL+

Because GTL is an open-drain interface, the selection of the pull-up resistor depends on the application requirement (for example, data rate) and PCB trace capacitance.

The FXGL2014 requires industrial standard LVTTL and GTL inputs. The design example in the Application Information section show standard voltage level and typical resistor values.





	Port A to Port B
	LVTTL to GTL
V _{CC}	3.3 V
V _{REF}	GND
V _{TT}	1.0 V
DIR	GND
R _T	75 Ω
R ₁	Not Available
R ₂	Not Available



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